Statement on non-use of HBCDD & Phthalates (DEHP, BBP, DBP, DINP, DNOP, DIBP and DIDP) In Texas Instruments (TI) Semiconductor Products

Texas Instruments continues to actively monitor regulatory requirements for new and proposed regulations that may restrict the use of additional substances in electronic products. An update to the EU RoHS Directive, (EU) 215/863, was released on 31 March 2015 restricting the use of 4 Phthalates in electrical and electronic equipment, these Phthalates are Bis(2-ethylhexyl) phthalate (DEHP), Butyl benzyl phthalate (BBP), Dibutyl phthalate (DBP) and Diisobutyl phthalate (DIBP). The law will come into effect on 22 July 2019.

The 4 Phthalates have already been evaluated with TI’s internal tracking systems and have been determined to not be contained in TI’s finished IC products. This database is developed from full material (homogeneous) reporting required from our suppliers for each material set approved for production. TI will have additional 3rd party test reports for materials used in IC products as further due diligence proof by late-2018 to support the 22 July 2019 effective date.

Verifying materials contained within finished TI IC products can be made online using the www.ti.com/productcontent web tool. As laws are released, any new testing requirements will take approximately 18 months to pass through the supply chain for applicable material sets.

Sincerely,

Mark Friman
SC Product Stewardship Management
SC Quality – Texas Instruments

Important Information/Disclaimer

TI bases its material content information on information provided by third-party suppliers and has taken, and continues to take, reasonably diligent steps to provide any required or available information. TI may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers may consider certain information to be proprietary, and thus certain information may not be available for release by TI. The material content information is provided by TI "as is."

For additional information, please contact TI customer support.